

24NM70

Power MOSFET

24A, 700V N-CHANNEL SUPER-JUNCTION MOSFET

■ DESCRIPTION

The **UTC 24NM70** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

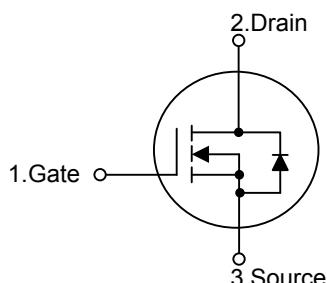
■ FEATURES

- * $R_{DS(ON)} \leq 0.19\Omega$ @ $V_{GS}=10V$, $I_D=12A$

- * High Switching Speed

- * 100% Avalanche Tested

■ SYMBOL



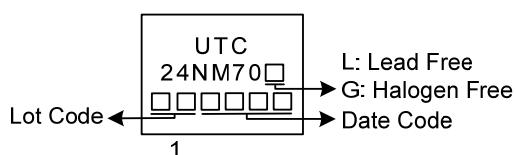
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
24NM70L-TF1-T	24NM70G-TF1-T	TO-220F1	G	D	S	Tube
24NM70L-TF2-T	24NM70G-TF2-T	TO-220F2	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

	(1) T: Tube (2) TF1: TO-220F1, TF2: TO-220F2 (3) G: Halogen Free and Lead Free, L: Lead Free
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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_c=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	± 30	V
Drain Current	Continuous	I_D	24	A
	Pulsed (Note 2)	I_{DM}	96	A
Avalanche Current (Note 2)		I_{AR}	5.2	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	879	mJ
Peak Diode Recovery dv/dt		dv/dt	6.3	V/ns
Power Dissipation		P_D	32	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L = 65\text{mH}$, $I_{AS} = 5.2\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq 24\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		θ_{JA}	62.5	$^\circ\text{C}/\text{W}$
Junction to Case		θ_{JC}	0.98	$^\circ\text{C}/\text{W}$

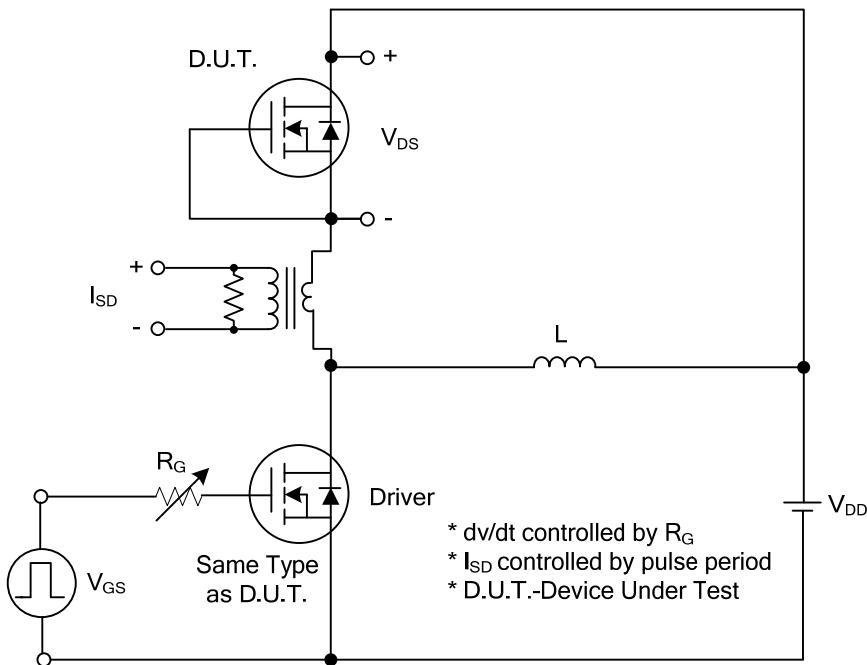
■ ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	$I_D=250\mu\text{A}$, $V_{GS}=0\text{V}$	700			V
Drain-Source Leakage Current		I_{DSS}	$V_{DS}=700\text{V}$, $V_{GS}=0\text{V}$			10	μA
Gate- Source Leakage Current	Forward	I_{GSS}	$V_{GS}=+30\text{V}$, $V_{DS}=0\text{V}$			+100	nA
	Reverse		$V_{GS}=-30\text{V}$, $V_{DS}=0\text{V}$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	2.5		4.5	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	$V_{GS}=10\text{V}$, $I_D=12\text{A}$		0.18	0.19	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C_{iss}	$V_{GS}=0\text{V}$, $V_{DS}=25\text{V}$, $f=1.0\text{MHz}$		2000		pF
Output Capacitance		C_{oss}			1280		pF
Reverse Transfer Capacitance		C_{rss}			110		pF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q_G	$V_{DS}=560\text{V}$, $V_{GS}=10\text{V}$, $I_D=24\text{A}$ $I_G= 1\text{mA}$ (Note1, 2)		70		nC
Gate to Source Charge		Q_{GS}			9.6		nC
Gate to Drain Charge		Q_{GD}			27.2		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	$V_{DS}=100\text{V}$, $V_{GS}=10\text{V}$, $I_D=24\text{A}$, $R_G=25\Omega$ (Note1, 2)		26		ns
Rise Time		t_R			32		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			240		ns
Fall-Time		t_F			110		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				24	A
Maximum Body-Diode Pulsed Current		I_{SM}				96	A
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	$I_S=24\text{A}$, $V_{GS}=0\text{V}$			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t_{rr}	$I_S=24\text{A}$, $V_{GS}=0\text{V}$, $dI/dt=100\text{A}/\mu\text{s}$		520		ns
Body Diode Reverse Recovery Charge		Q_{rr}			10.5		μC

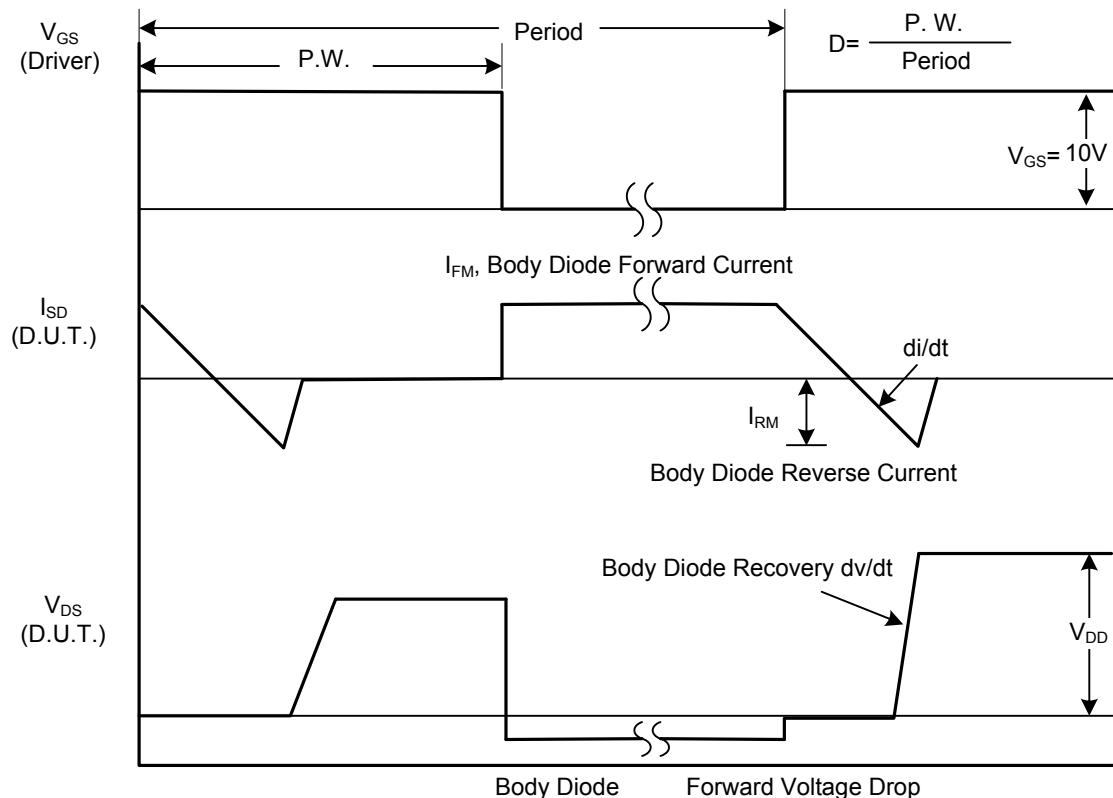
Notes: 1. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating ambient temperature.

■ TEST CIRCUITS AND WAVEFORMS

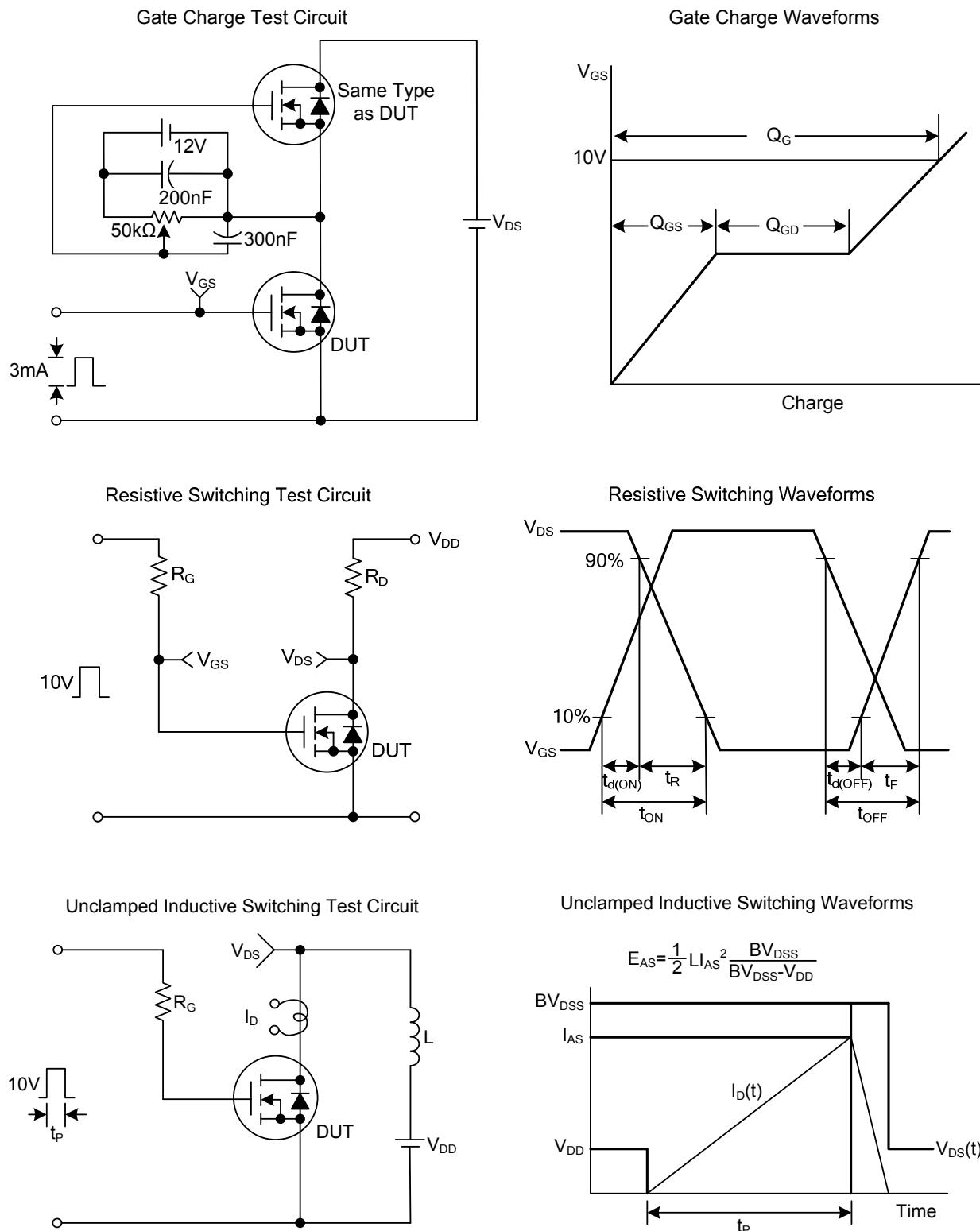


Peak Diode Recovery dv/dt Test Circuit

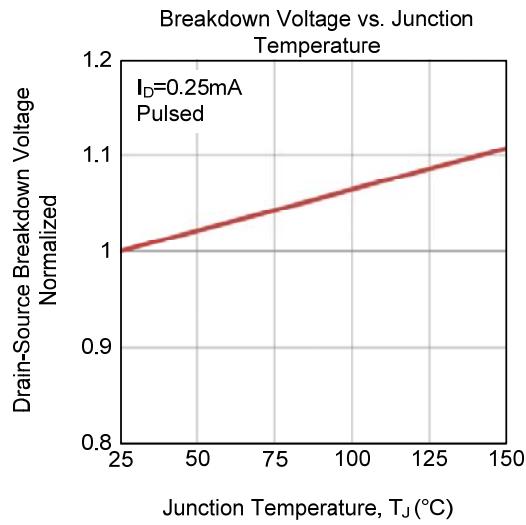
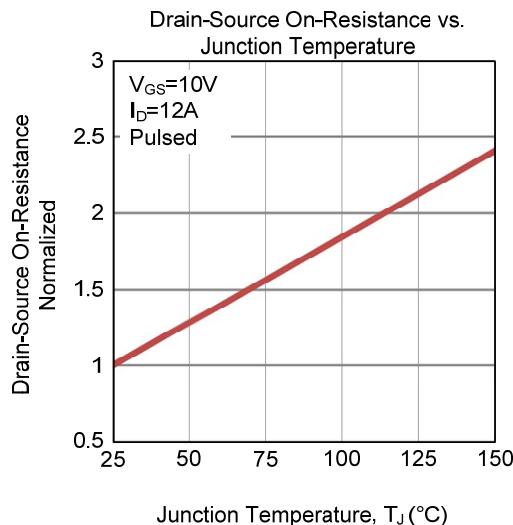
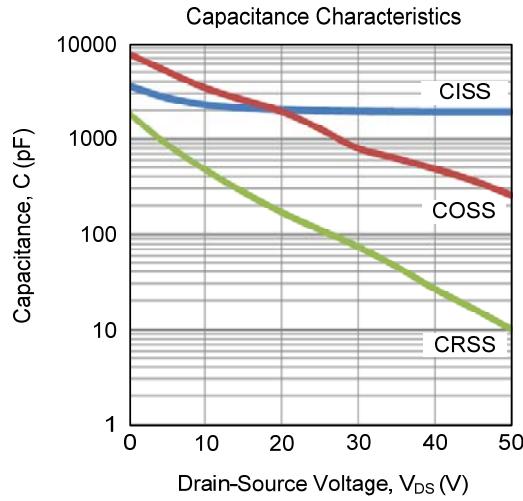
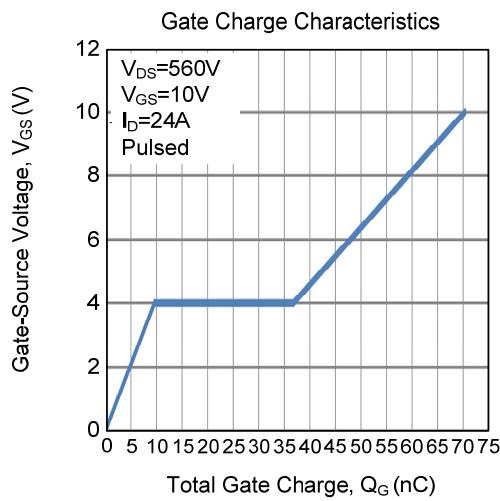
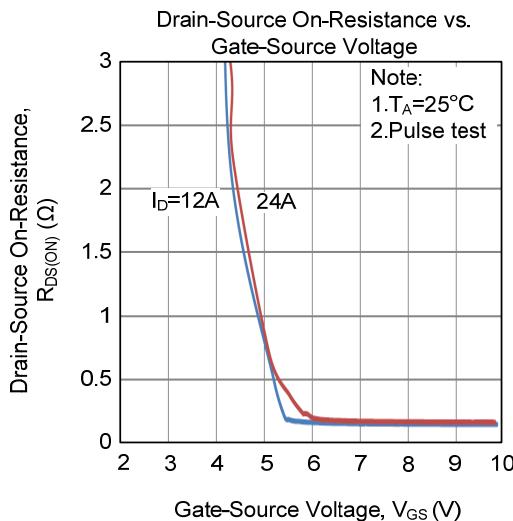
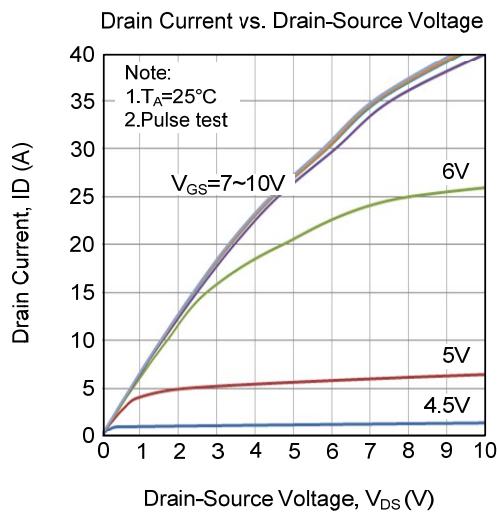


Peak Diode Recovery dv/dt Waveforms

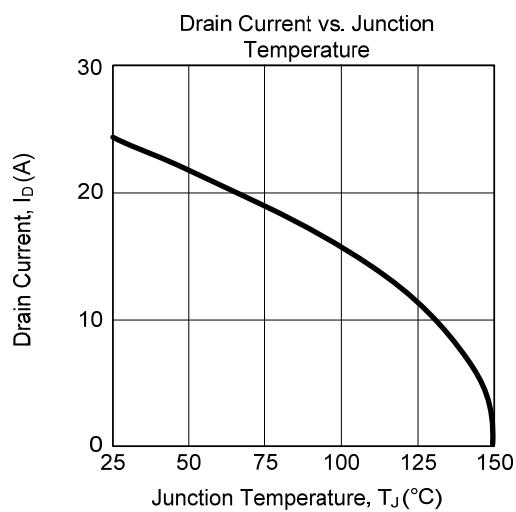
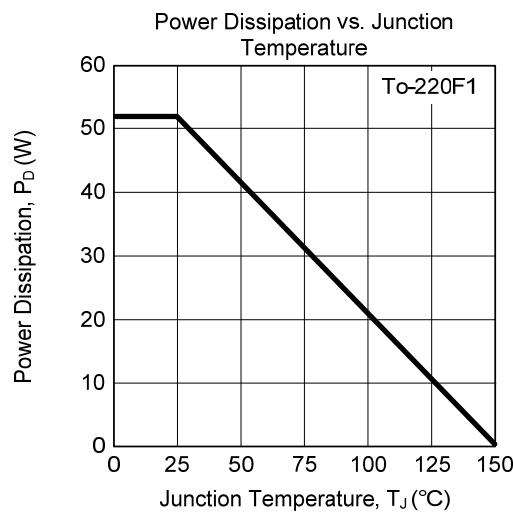
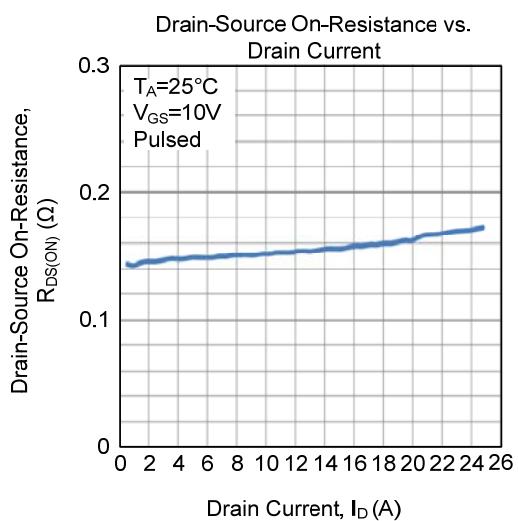
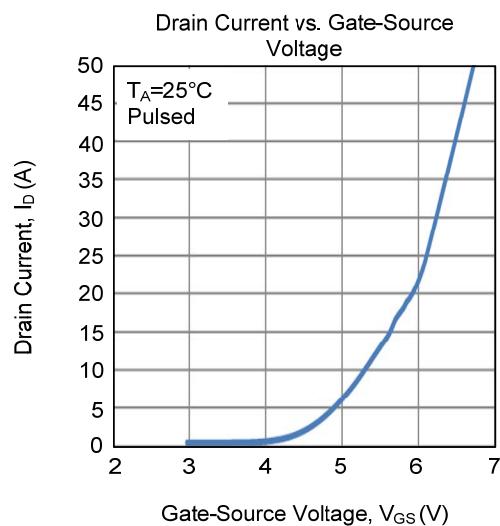
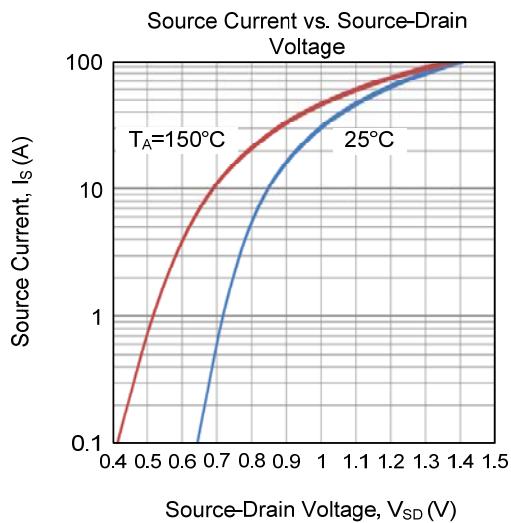
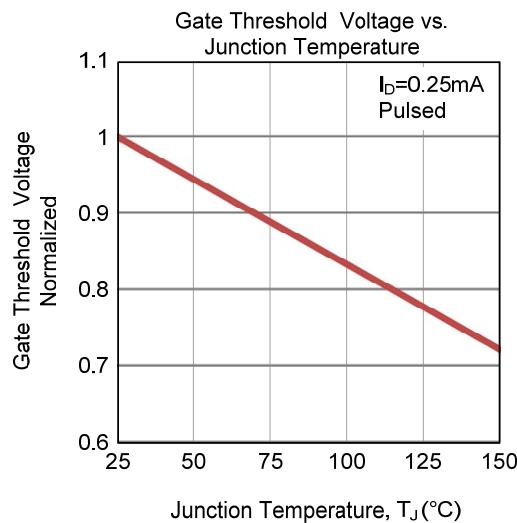
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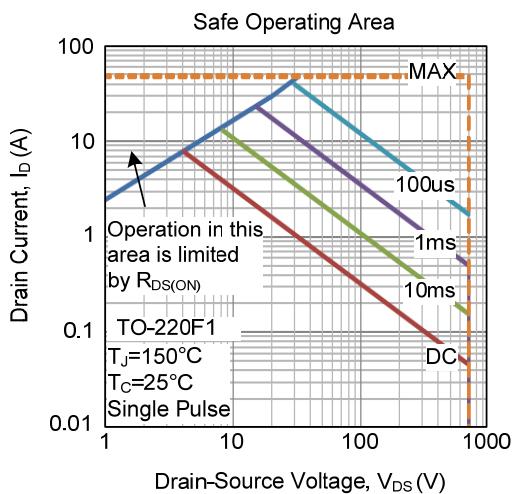


■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)

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